

For Organizer use only

Zone of Exhibits: _____
 Booth No. : _____
 Space : _____ (sq.m.)
 Payment : _____

Part Space Application

Deadline: Nov. 12, 2005

Please use English to complete this form in print. The information will be used in the Show Catalogue. Please send fax, mail or email to:

Shanghai YingZhan Business Service Co., Ltd. Tel: +8621 54901782, 54904394, 54901915 Fax: +8621 54904537
 Unit D., 23/F, Huijia Building, No. 41, Cao Xi Road (N), Shanghai 200030, China Email: cpcashow@ying-zhan.com, yinzhan@online.sh.cn

Company Name: _____
 Chinese Company Name (if any): _____
 Person in Charge: Mr. Ms. _____ E-mail: _____
 Title: _____ Mobile: _____
 Contact Person: Mr. Ms. _____
 Title: _____ Mobile: _____
 * Only for the contact between the Organizer and the exhibitor
 Address(English): _____
 Address(Chinese): _____
 Postal Code: _____ Country/Region: _____ City: _____
 Telephone No.: _____
 Country Code Area Code Number
 Fax No.: _____
 E-mail: _____
 Website: _____
 Products: _____
 Brand Name(s): _____

Membership Yes (Please tick the appropriate box.) No

CPCA JPCA KPCA EFIP HKPCA IPC IPCA TPCA Member No.: _____

STAND REQUEST

Option	Type	Member	Non-member	No. of Booth	Participation Fee
A	9m ² Standard Booth (3m x 3m)	RMB 2,750/m ²	RMB 2,940/m ²	Unit m ²	
	Corner Booth	RMB 809/unit		Unit	
B	Raw Space · Exhibitor needs to build the stand themselves · min .36sq.m. & carpet excluded · booth management fee excluded · Raw space requirement is applicable only for exhibitor who applies for the participation independently.	RMB 2,395/m ²	RMB 2,470/m ²	m x m m ²	
	Additional charge for double-deck booth(s)	Booth Rental x 30%			
C	Co-exhibitor(s) · The exhibitor is entitled to have co-exhibitors at his stand, provided he has submitted application and obtained the Organizer's consent.	RMB 799/each exhibitor		Exhibitor(s)	

* All banking charges, if any, are to be borne by the exhibitor.

Total Fee Payable: RMB

Payment Arrangement

RMB (Chinese mainland)

USD Country / Region of your remittance

We hereby apply for joining the 15th International Electronic Circuits Exhibition. We agree to abide by the "Terms of Application and Exhibition Rules & Regulations" set out by the Organizer. We understand that the Organizer is entitled to make use of the information provided above, or on-pass to third parties, for the promotion purpose of the 15th International Electronic Circuits Exhibition. We accept that the Organizer assumes no responsibility for any error or omission.

We hereby certify that the information given above is all true and correct. If any of the information is found to be incorrect or misleading, the Organizer reserve the right to terminate our participation in the show and we cannot make any claim against the Organizer for refund of any monies paid.

If you do not wish to have your information on-passed to third parties for promotion of the 15th International Electronic Circuits Exhibition, excluding the production of the official show printed matters, please check against the box.

Company Name: _____ Name of Applicant: _____

Stamp & Authorized Signature: _____ Date: _____

Part Supplementary Information
Deadline: Nov. 12, 2005

Company Name: _____

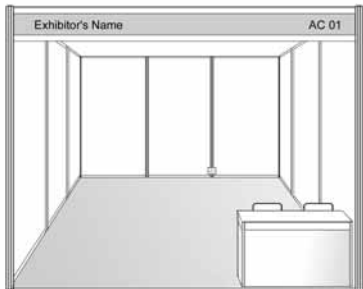
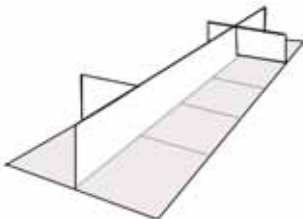
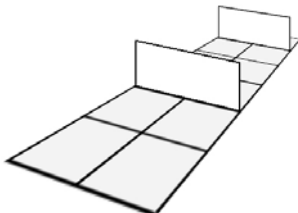

Classification

Company Classified as	Manufacturer	Distributor / Agent	Other (Please advice) _____
1 Printed Circuit Board PCB Manufacturing PCB Equipments PCB Raw Materials and Chemicals	2 Electronics Assembly Electronics Assembly Equipment Electronics Assembly Materials Electronic Manufacturing Services / Contract Manufacturer	3 Others Cleanroom Technology and Service Clearing Water Technology and Equipment Newspaper & Magazine Schools, Research Institute, Business or Trade Association, Information & Consulting	

Exhibits

Exhibit(s)	Producing Area	Brand	Category	Dimension, Weight & Special Requirement

Booth / Space Type

A、Standard 	B、In-Line 	C、Block 	D、Island 
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Seminar

Are you interested in delivering a speech at the seminar?	Yes	No
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Sponsorship

Are you interested in the Sponsorships at the show?	Yes	No
The plan includes ad. on the Directory, ticket, bag, banner and at seminars or related meetings. Detailed information will be sent to you upon request.		

Part Product Index

Deadline: Nov. 12, 2005

Company Name: _____

A. Printed Circuit Board

- ☐ A1 Single Sided Board
- ☐ A2 Double Sided Board
- ☐ A3 Multi Layer Board
- ☐ A4 Flexible Board
- ☐ A5 Package Substrate
- ☐ A6 Others (Please advice) _____

B. PCB Equipments

- ☐ B1 Pre-Production Preparation
- ☐ B2 Issue Lamine Process
- ☐ B3 Inner Layer Process
- ☐ B4 Laminating Process
- ☐ B5 Drilling/Punching Machine
- ☐ B6 Pattern Process
- ☐ B7 Panel Copper Plating Process
- ☐ B8 DES Line
- ☐ B9 Pattern Plating Process

- ☐ B10 Outer Layer Fabrication
- ☐ B11 Direct Metallization Plating Process
- ☐ B12 Resisting Process
- ☐ B13 Screen Printing Process
- ☐ B14 Reflow Process
- ☐ B15 Hot Air Leveling Process
- ☐ B16 Surface Treatment Process
- ☐ B17 Routing Process
- ☐ B18 Testing Equipment
- ☐ B19 Packing Process
- ☐ B20 Automatic Equipment
- ☐ B21 Environmental Engineering Equipment
- ☐ B22 Miscellaneous Equipment for PCB
- ☐ B23 Others (Please advice) _____

C. PCB Materials

- ☐ C1 Resin
- ☐ C2 Copper Foil

- ☐ C3 Glass Fiber
- ☐ C4 Base Materials
- ☐ C5 Inner Layer
- ☐ C6 Lamination Process
- ☐ C7 Drilling
- ☐ C8 Image Transfer
- ☐ C9 PTH Chemicals
- ☐ C10 Direct Metallization
- ☐ C11 Electroplating Chemical
- ☐ C12 Tin/Lead Plating Chemical
- ☐ C13 Out Layer Fabrication
- ☐ C14 Ink
- ☐ C15 Emulsion
- ☐ C16 Solder Mask
- ☐ C17 Screen Printing
- ☐ C18 Gold Finger
- ☐ C19 Surface Treatment
- ☐ C20 Others (Please advice) _____

D. Electronics Assembly Equipment

- ☐ D1 AOI Equipment
- ☐ D2 Chip Placement
- ☐ D3 Component Insertion
- ☐ D4 Feeding Systems – Bulk
- ☐ D5 Fine Pitch Placement
- ☐ D6 Flip Chip Technology
- ☐ D7 Multifunctional Placement
- ☐ D8 Odd Form Assembly
- ☐ D9 Ball Placement Systems & Equipment
- ☐ D10 Barcode Printers / Readers
- ☐ D11 Board Handling Equipment (Conveyors & Depanelizers)
- ☐ D12 Brushes
- ☐ D13 Carts, Racks, Accessories
- ☐ D14 Cleaning Equipment / Systems
- ☐ D15 Coating Equipment / Systems
- ☐ D16 Component Preparation
- ☐ D17 Curing Equipment / Systems
- ☐ D18 Data Acquisition Software / Systems
- ☐ D19 Dicing Equipment
- ☐ D20 Die Bonding Equipment
- ☐ D21 Dispensing Equipment
- ☐ D22 Dryers / Drying Systems
- ☐ D23 Encapsulation Equipment
- ☐ D24 Environmental & Waste Treatment / Management
- ☐ D25 Equipment Lease, Refurbish, Resale
- ☐ D26 Fans & Blowers
- ☐ D27 Flip Chip Bonding Equipment
- ☐ D28 Fume Extraction Systems
- ☐ D29 Gas Atmosphere Systems
- ☐ D30 Hand Tools
- ☐ D31 Labeling Systems
- ☐ D32 Laser Systems
- ☐ D33 Lighting

- ☐ D34 Marking Tools / Systems
- ☐ D35 Masking, Demasking Systems
- ☐ D36 Masks & Screens for Soldering / Printing
- ☐ D37 Motion Control / Automation
- ☐ D38 Pallets & Carriers
- ☐ D39 Reclamation / Recovery Systems (Environmental)
- ☐ D40 Reflow Soldering Equipment (Ovens)
- ☐ D41 Repair & Rework
- ☐ D42 Software – CAD/CAM
- ☐ D43 Software – Process Control
- ☐ D44 Software – Test, Measurement, Inspection
- ☐ D45 Solderability Test Systems
- ☐ D46 Soldering Equipment, Other
- ☐ D47 Soldering Equipment, Selective
- ☐ D48 Soldering Irons, Tips, Stations
- ☐ D49 Stencil Cleaning Systems
- ☐ D50 Stencil Printing Systems
- ☐ D51 Stencils & Accessories
- ☐ D52 Tape & Reel, Equipment & Services
- ☐ D53 Test & Inspection, Solder Paste
- ☐ D54 Test & Measurement Equipment, Functional
- ☐ D55 Test & Measurement Equipment, In-circuit
- ☐ D56 Test & Measurement Equipment, Infrared
- ☐ D57 Test & Measurement Equipment, Package
- ☐ D58 Test & Measurement Equipment, Vision / Videos
- ☐ D59 Test & Measurement Equipment, X-ray
- ☐ D60 Test Fixtures
- ☐ D61 Test, Environmental Chambers
- ☐ D62 Test, Inspection & Measurement, Test Handlers

- ☐ D63 Test, Inspection & Measurement, Miscellaneous
- ☐ D64 Thermal Profiling
- ☐ D65 Wafer Bumping Equipment
- ☐ D66 Wave Soldering Equipment
- ☐ D67 Wire Bonding Equipment
- ☐ D68 Wire Cutting, Stripping, Wrapping Machine Tools
- ☐ D69 Work Benches / Work Stations
- ☐ D70 Workstations / Ergonomics / Chairs
- ☐ D71 Others (Please advice) _____

E. Electronics Assembly Materials

- ☐ E1 Adhesives
- ☐ E2 Cleaning Agents / Solvents
- ☐ E3 Coatings (Conformal), etc.
- ☐ E4 Component Packaging Products
- ☐ E5 Components
- ☐ E6 Connectors, Fasteners, Hardware
- ☐ E7 Distributor
- ☐ E8 EOS / ESD Handling Products & Services
- ☐ E9 Flux
- ☐ E10 Gases – Specialty
- ☐ E11 Chip Packaging Materials
- ☐ E12 Solder (Paste, Bar, Cream, Powder)
- ☐ E13 Others (Please advice) _____

F. Electronic Manufacturing Services / Contract Manufacturer

- ☐ F1 Consignment EMS
- ☐ F2 Medium Volume EMS
- ☐ F3 Turn-key EMS
- ☐ F4 High Volume EMS
- ☐ F5 New Product Introduction EMS
- ☐ F6 Prototype EMS
- ☐ F7 Others (Please advice) _____

G. Others

- ☐ G1 Cleanroom Technology and Service
- ☐ G2 Clearing Water Technology and Equipment

- ☐ G3 Newspaper & Magazine
- ☐ G4 Schools & Research Institutes
- ☐ G5 Information & Consulting

- ☐ G6 Business or Trade Associations
- ☐ G7 Others (Please advice) _____